

# STPS3150-Y

## Automotive power Schottky rectifier

## Features

- AEC-Q101 qualified
- Negligible switching losses
- Low forward voltage drop for higher efficiency and extented battery life
- Low thermal resistance
- ECOPACK<sup>®</sup>2 compliant component

## Description

Packaged in SMB, this device is intended for use in automotive applications where low drop forward voltage is required to reduce power dissipation.



### Table 1.Device summary

Symbol	Value
I <sub>F(AV)</sub>	3 A
V <sub>RRM</sub>	150 V
T <sub>j</sub> (max)	175 °C
V <sub>F</sub> (max)	0.67 V

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## 1 Characteristics

### Table 2. Absolute ratings (limiting values)

Parameter	Value	Unit	
Repetitive peak reverse voltage	150	V	
Average forward current	$T_L = 130 \ ^{\circ}C \ \delta = 0.5$	3	А
Surge non repetitive forward current $t_p = 10 \text{ ms sinusoidal}$		80	А
Storage temperature range	-65 to +175	°C	
Operating junction temperature range <sup>(1)</sup>	-40 to +175	°C	
	Repetitive peak reverse voltage Average forward current	Repetitive peak reverse voltageAverage forward current $T_L = 130 \ ^{\circ}C \ \delta = 0.5$ Surge non repetitive forward current $t_p = 10 \ \text{ms sinusoidal}$ Storage temperature range	Repetitive peak reverse voltage150Average forward current $T_L = 130 \degree C \ \delta = 0.5$ 3Surge non repetitive forward current $t_p = 10 \ ms \ sinusoidal$ 80Storage temperature range-65 to +175

1.  $\frac{dPtot}{dTj} < \frac{1}{Rth(j-a)}$  condition to avoid thermal runaway for a diode on its own heatsink

### Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
R <sub>th(j-l)</sub>	Junction to lead	20	°C/W

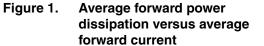
### Table 4. Static electrical characteristics

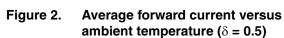
Symbol	Parameter	Tests conditions		Min.	Тур	Max.	Unit
I <sub>B</sub> <sup>(1)</sup>	Reverse leakage current	T <sub>j</sub> = 25 °C	- V <sub>R</sub> = V <sub>RRM</sub> -		0.4	2.0	μA
'R '	neverse leakage current	T <sub>j</sub> = 125 °C			0.6	2.0	mA
		T <sub>j</sub> = 25 °C	I⊢ = 3 A		0.78	0.82	
V <sub>F</sub> <sup>(2)</sup>	Forward voltage drop	T <sub>j</sub> = 125 °C				0.63	0.67
VF V	$T_i = 25 \text{ °C}$		0.85	0.89	v		
		T <sub>j</sub> = 125 °C	I <sub>F</sub> = 6 A		0.70	0.75	

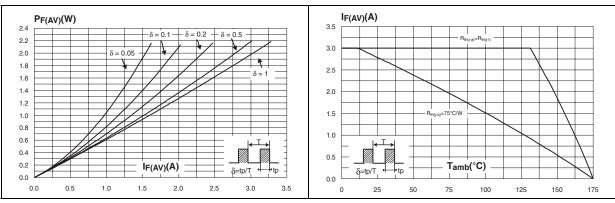
1.  $t_p = 5 \text{ ms}, \delta < 2\%$ 

2. t<sub>p</sub> = 380 μs, δ < 2%

To evaluate the conduction losses use the following equation: P = 0.59 x  $I_{F(AV)}$  + 0.023  ${I_F}^2_{(RMS)}$ 









#### Figure 3. Non repetitive surge peak forward current versus overload duration (maximum values)

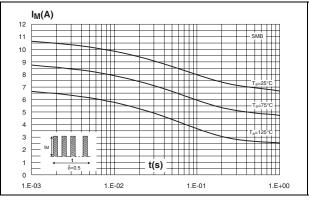
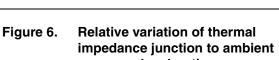
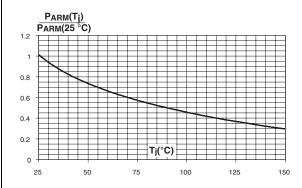


Figure 5. Normalized avalanche power derating versus junction temperature





0.3 0.2 0.1 0.0

Figure 7. Reverse leakage current versus reverse voltage applied (typical values)

1.E-02 1.E-01 1.E+00 1.E+01 1.E+02

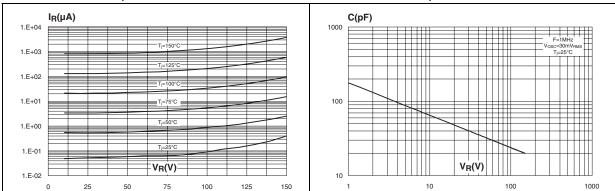
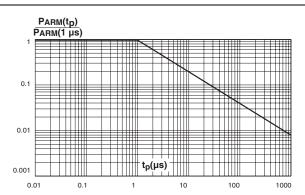


Figure 4. Normalized avalanche power derating versus pulse duration



versus pulse duration

t<sub>p</sub>(s)

δ=tp/T

1.E+03

 $Z_{th(j-a)}/R_{th(j-a)}$ 

THH

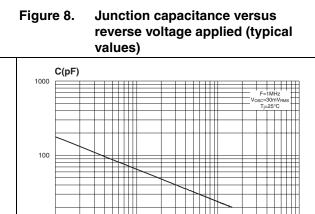
1.0

0.9

0.8 0.7

0.6 0.5

0.4



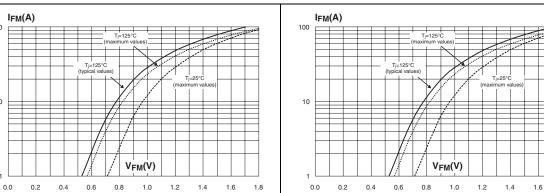
100

10

1

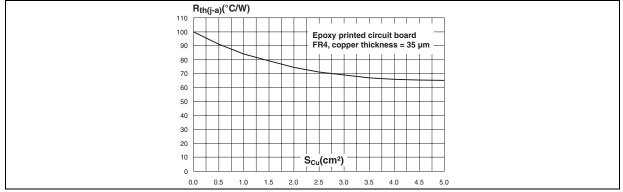
1.8

#### Figure 9. Forward voltage drop versus forward current



### Figure 10. Forward voltage drop versus forward current







## 2 Package information

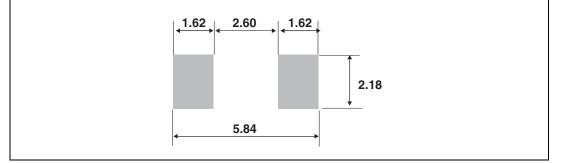
- Epoxy meets UL94, V0
- Lead-free package

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <u>www.st.com</u>. ECOPACK<sup>®</sup> is an ST trademark.

Table 5. SMB dimensions

			Dimensions			
E1	F1		Millimeters		Inches	
			Min.	Max.	Min.	Max.
		A1	1.90	2.45	0.075	0.096
		A2	0.05	0.20	0.002	0.008
		b	1.95	2.20	0.077	0.087
		С	0.15	0.40	0.006	0.016
		Е	5.10	5.60	0.201	0.220
		E1	4.05	4.60	0.159	0.181
		D	3.30	3.95	0.130	0.156
		L	0.75	1.50	0.030	0.059

Figure 12. SMB footprint (dimensions in mm)





## **3** Ordering information

### Table 6. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS3150UY	G315Y	SMB	0.107 g	2500	Tape and reel

## 4 Revision history

### Table 7.Document revision history

	Date	Revision	Description of Changes
03	-Nov-2011	1	Initial release.



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